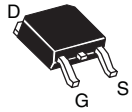


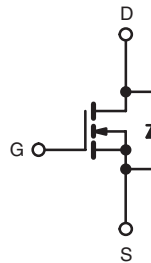
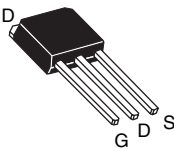
Power MOSFET

PRODUCT SUMMARY	
V_{DS} (V)	500
$R_{DS(on)}$ (Ω)	$V_{GS} = 10\text{ V}$ 1.7
Q_g (Max.) (nC)	24
Q_{gs} (nC)	6.5
Q_{gd} (nC)	13
Configuration	Single

DPAK (TO-252)



IPAK (TO-251)



N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Low Gate Charge Q_g Results in Simple Drive Requirement
- Improved Gate, Avalanche and Dynamic dV/dt Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective C_{OSS} Specified
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

ORDERING INFORMATION					
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)
Lead (Pb)-free and Halogen-free	SiHFR430A-GE3	SiHFR430ATR-GE3 ^a	SiHFR430ATRL-GE3 ^a	SiHFR430ATRR-GE3 ^a	SiHFU430A-GE3
Lead (Pb)-free	IRFR430APbF	IRFR430ATRPbF ^a	IRFR430ATRLPbF ^a	IRFR430ATRRPbF ^a	IRFU430APbF
	SiHFR430A-E3	SiHFR430AT-E3 ^a	SiHFR430ATL-E3 ^a	SiHFR430ATR-E3 ^a	SiHFU430A-E3
SnPb	IRFR430A	IRFR430ATR ^a	IRFR430ATRL ^a	IRFR430ATRR ^a	IRFU430A
	SiHFR430A	SiHFR430AT ^a	SiHFR430ATL ^a	SiHFR430ATR ^a	SiHFU430A

Note

a. See device orientation.


ABSOLUTE MAXIMUM RATINGS $T_C = 25\text{ }^\circ\text{C}$, unless otherwise noted				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V_{DS}	500	V	
Gate-Source Voltage	V_{GS}	± 30		
Continuous Drain Current	V_{GS} at 10 V	$T_C = 25\text{ }^\circ\text{C}$	5.0	A
		$T_C = 100\text{ }^\circ\text{C}$	3.2	
Pulsed Drain Current ^a		I_{DM}	20	
Linear Derating Factor			0.91	W/ $^\circ\text{C}$
Single Pulse Avalanche Energy ^b		E_{AS}	130	mJ
Repetitive Avalanche Current ^a		I_{AR}	5.0	A
Repetitive Avalanche Energy ^a		E_{AR}	11	mJ
Maximum Power Dissipation	$T_C = 25\text{ }^\circ\text{C}$	P_D	110	W
Peak Diode Recovery dV/dt ^c		dV/dt	3.0	V/ns
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	

Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- Starting $T_J = 25\text{ }^\circ\text{C}$, $L = 11\text{ mH}$, $R_g = 25\text{ }\Omega$, $I_{AS} = 5.0\text{ A}$ (see fig. 12).
- $I_{SD} \leq 5.0\text{ A}$, $dI/dt \leq 320\text{ A}/\mu\text{s}$, $V_{DD} \leq V_{DS}$, $T_J \leq 150\text{ }^\circ\text{C}$.
- 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	62	°C/W
Case-to-Sink, Flat, Greased Surface	R_{thCS}	0.50	-	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.1	

SPECIFICATIONS $T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	500	-	-	V	
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to $25\text{ }^\circ\text{C}, I_D = 1\text{ mA}$	-	0.60	-	V/°C	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	2.0	-	4.5	V	
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 30\text{ V}$	-	-	± 100	nA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 500\text{ V}, V_{GS} = 0\text{ V}$	-	-	25	μA	
		$V_{DS} = 400\text{ V}, V_{GS} = 0\text{ V}, T_J = 125\text{ }^\circ\text{C}$	-	-	250		
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 3.0\text{ A}^b$	-	-	1.7	Ω	
Forward Transconductance	g_{fs}	$V_{DS} = 50\text{ V}, I_D = 3.0\text{ A}$	2.3	-	-	S	
Dynamic							
Input Capacitance	C_{iss}	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1.0\text{ MHz}, \text{ see fig. 5}$	-	490	-	pF	
Output Capacitance	C_{oss}		-	75	-		
Reverse Transfer Capacitance	C_{rss}		-	4.5	-		
Output Capacitance	C_{oss}	$V_{GS} = 10\text{ V}$	$V_{DS} = 1.0\text{ V}, f = 1.0\text{ MHz}$	-	750	-	pF
Effective Output Capacitance	$C_{oss\text{ eff.}}$		$V_{DS} = 400\text{ V}, f = 1.0\text{ MHz}$	-	25	-	
Total Gate Charge	Q_g	$V_{GS} = 10\text{ V}$	$I_D = 5.0\text{ A}, V_{DS} = 400\text{ V}, \text{ see fig. 6 and 13}^b$	-	-	24	nC
Gate-Source Charge	Q_{gs}			-	-	6.5	
Gate-Drain Charge	Q_{gd}			-	-	13	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 250\text{ V}, I_D = 5.0\text{ A}, R_g = 15\text{ }\Omega, R_D = 50\text{ }\Omega, \text{ see fig. 10}^b$	-	8.7	-	ns	
Rise Time	t_r		-	27	-		
Turn-Off Delay Time	$t_{d(off)}$		-	17	-		
Fall Time	t_f		-	16	-		
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode 	-	-	5.0	A	
Pulsed Diode Forward Current ^a	I_{SM}		-	-	20		
Body Diode Voltage	V_{SD}	$T_J = 25\text{ }^\circ\text{C}, I_S = 5.0\text{ A}, V_{GS} = 0\text{ V}^b$	-	-	1.5	V	
Body Diode Reverse Recovery Time	t_{rr}	$T_J = 25\text{ }^\circ\text{C}, I_F = 5.0\text{ A}, dI/dt = 100\text{ A}/\mu\text{s}^b$	-	410	620	ns	
Body Diode Reverse Recovery Charge	Q_{rr}		-	1.4	2.1	μC	
Forward Turn-On Time	t_{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					

Notes

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- Pulse width $\leq 300\text{ }\mu\text{s}$; duty cycle $\leq 2\%$.
- $C_{oss\text{ eff.}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80 % V_{DS} .

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

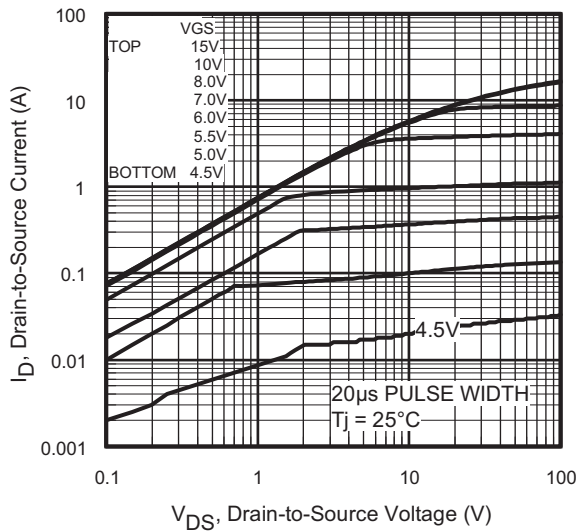


Fig. 1 - Typical Output Characteristics

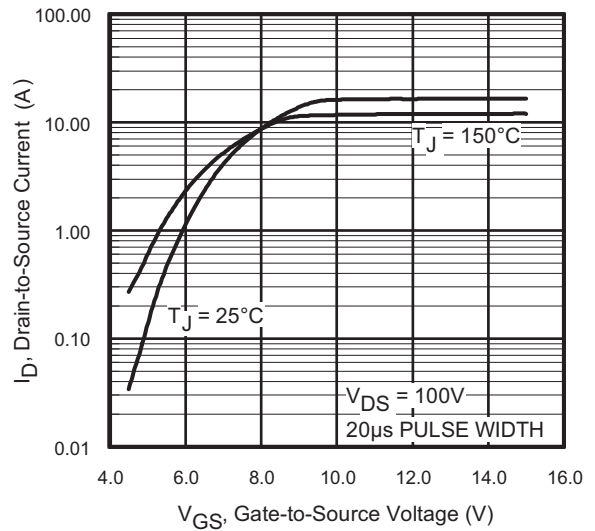


Fig. 3 - Typical Transfer Characteristics

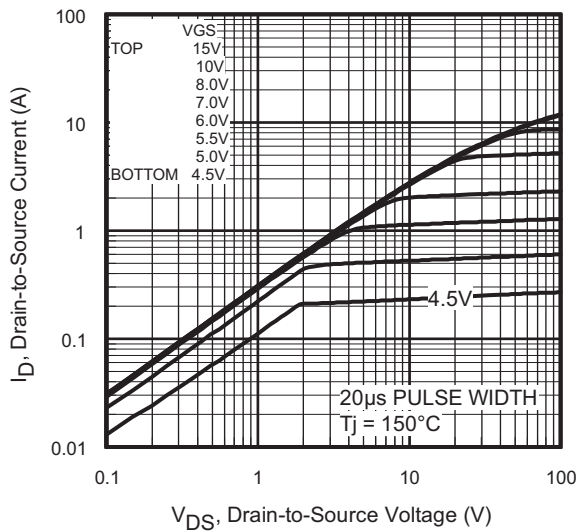


Fig. 2 - Typical Output Characteristics

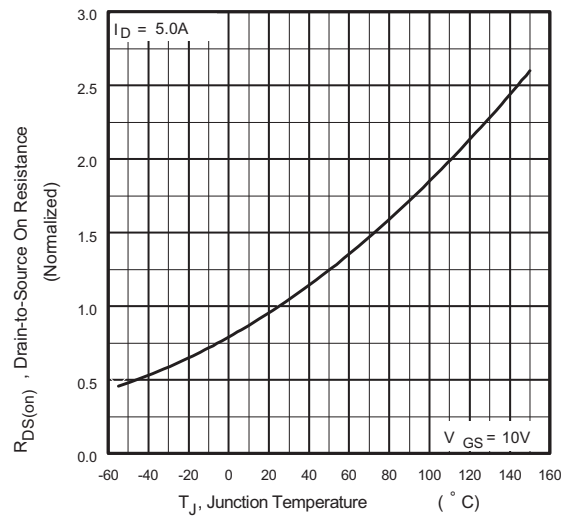


Fig. 4 - Normalized On-Resistance vs. Temperature

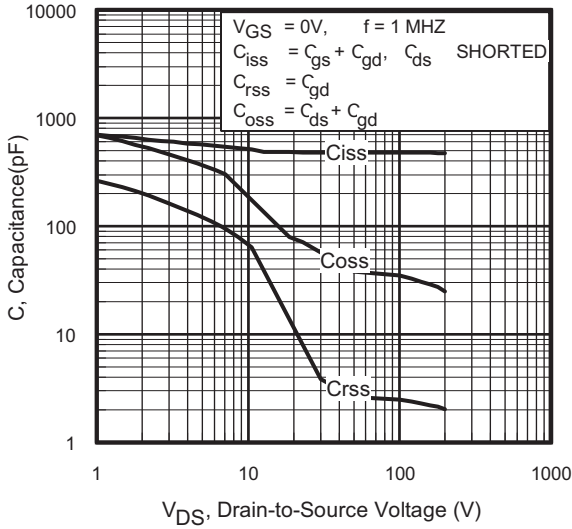


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

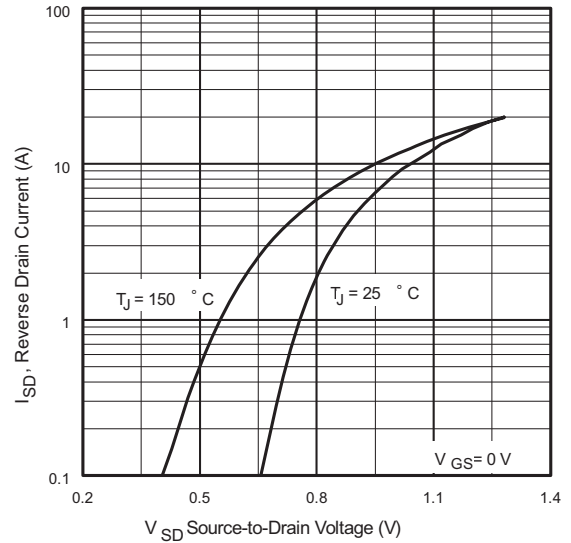


Fig. 7 - Typical Source-Drain Diode Forward Voltage

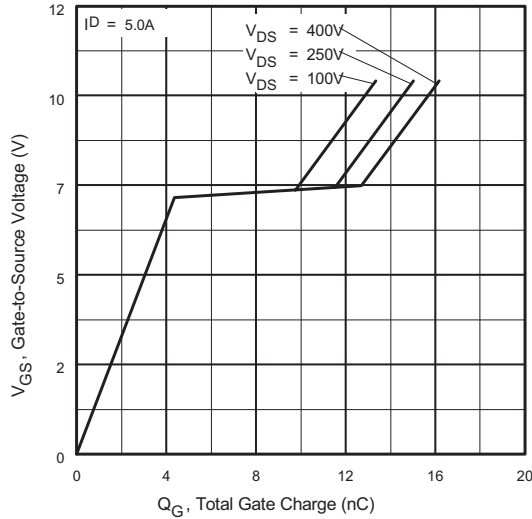


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

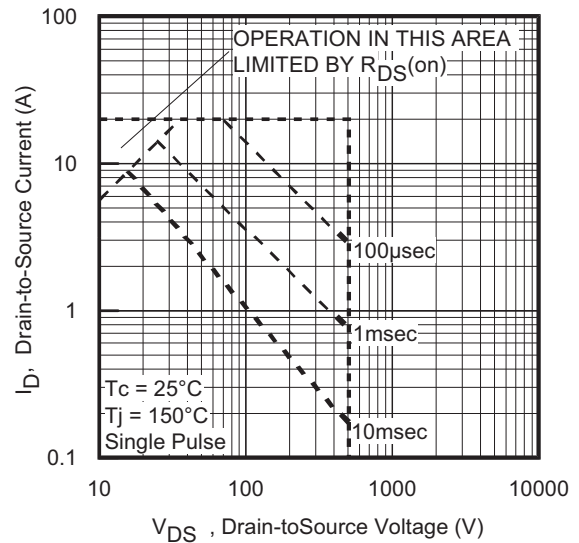


Fig. 8 - Maximum Safe Operating Area

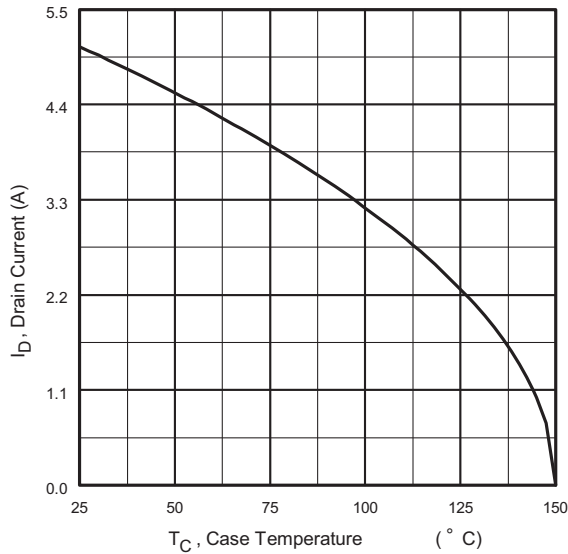


Fig. 9 - Maximum Drain Current vs. Case Temperature

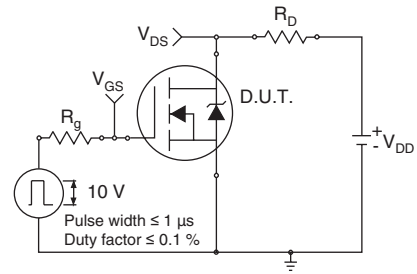


Fig. 10a - Switching Time Test Circuit

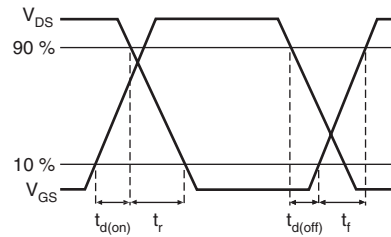


Fig. 10b - Switching Time Waveforms

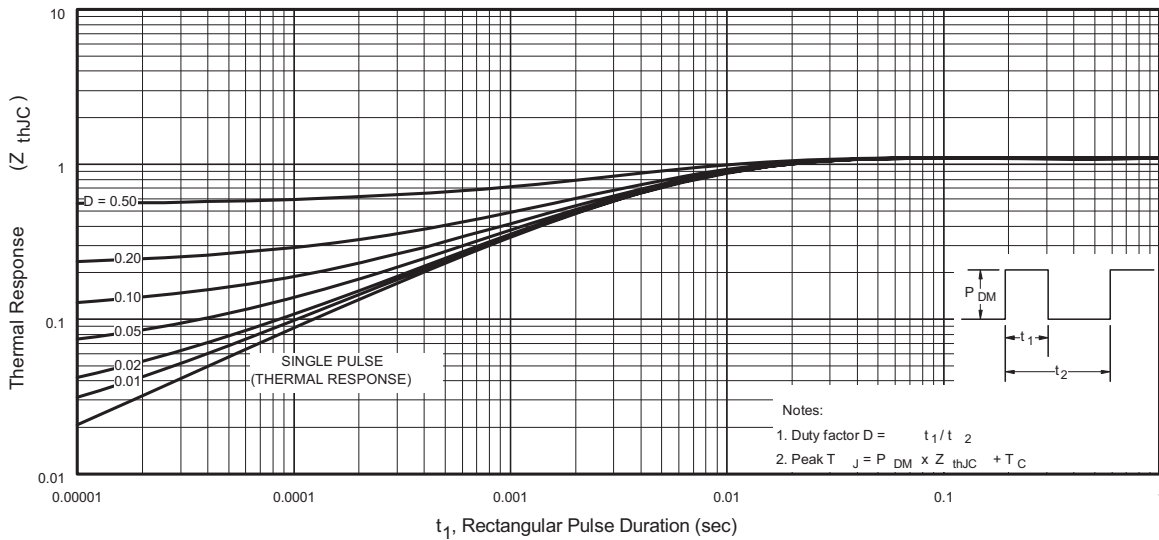


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

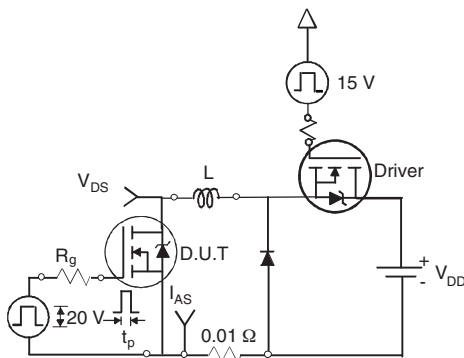


Fig. 12a - Unclamped Inductive Test Circuit

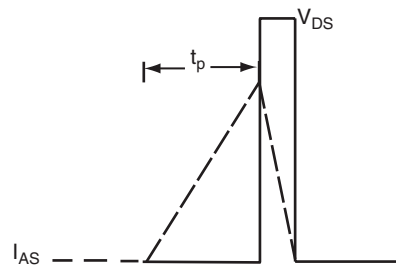


Fig. 12b - Unclamped Inductive Waveforms

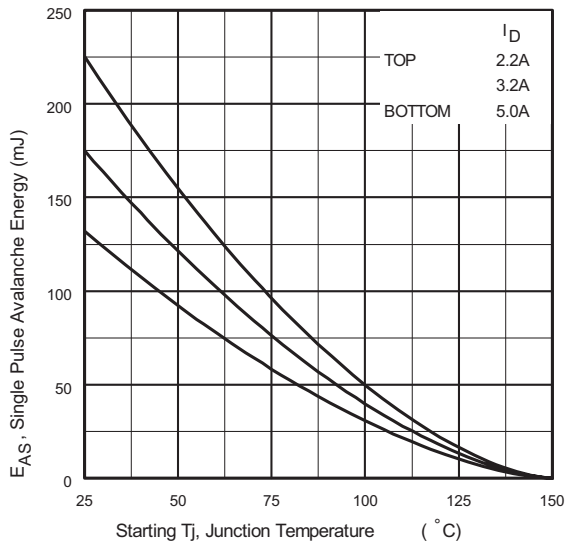


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

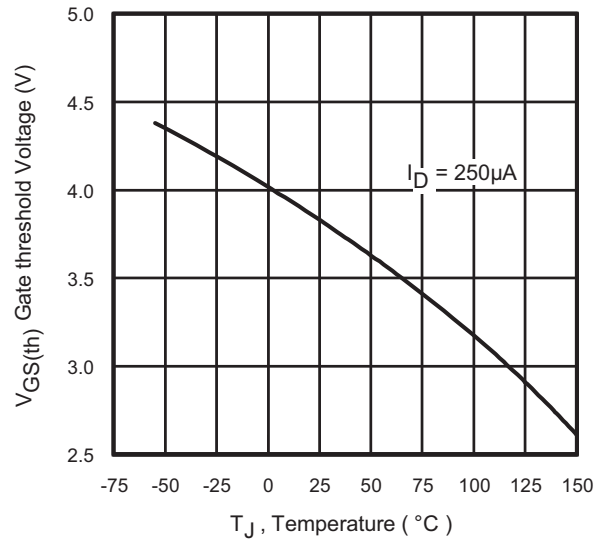


Fig. 12d - Threshold Voltage vs. Temperature

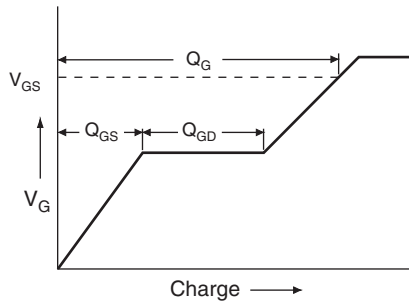


Fig. 13a - Basic Gate Charge Waveform

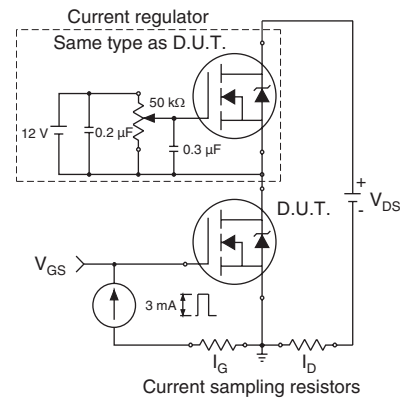
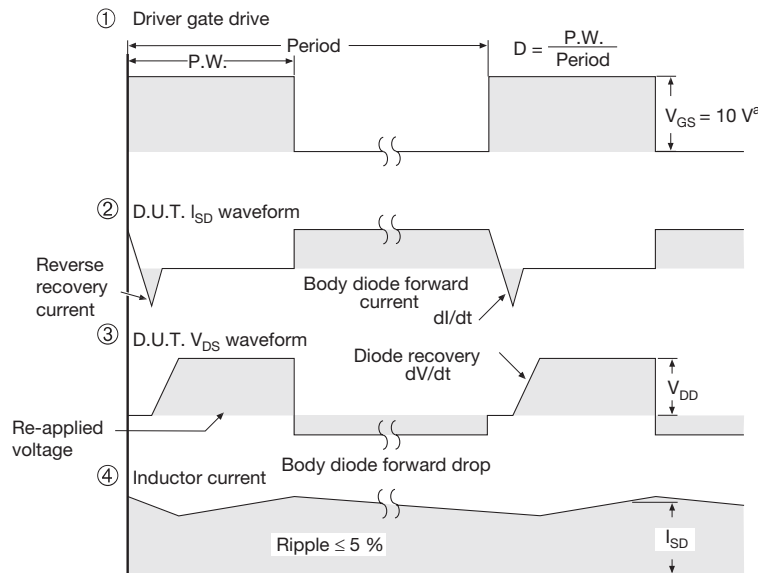
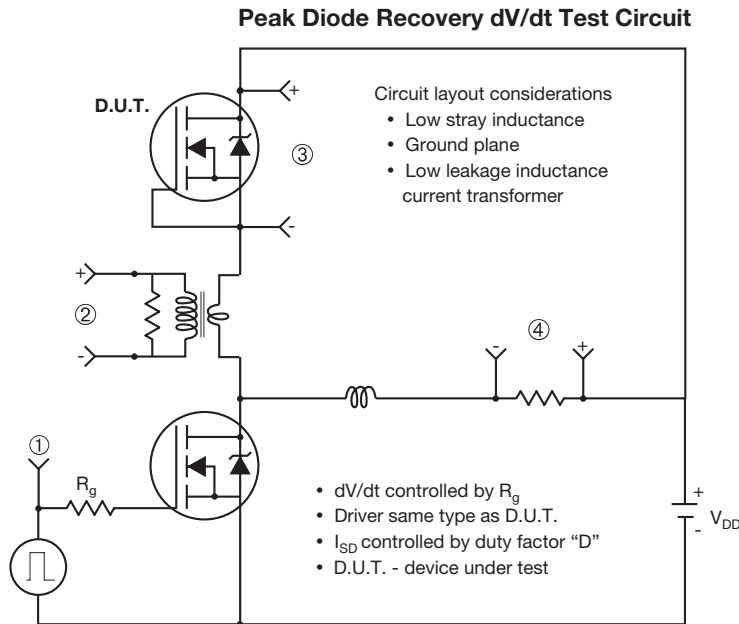


Fig. 13b - Gate Charge Test Circuit



Note

a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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